



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**Notification# 20230522006.1  
Datasheet for THS402x  
Change Notification**

**Date:** May 23, 2023  
**To:** Keysight Technologies PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team ([PCN ww admin team@list.ti.com](mailto:PCN_admin_team@list.ti.com)).

Sincerely,

PCN Team  
SC Business Services


## **Data Sheet Change Notification Attachments**

### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
THS4021CDGNR	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20230522006.1	<b>PCN Date:</b>	May 23, 2023
<b>Title:</b>	Datasheet for THS402x		
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services
<b>Proposed 1<sup>st</sup> Ship Date:</b>	Aug. 22, 2023		
<b>Change Type:</b>			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	
<b>Notification Details</b>			
<b>Description of Change:</b>			
<p>Texas Instruments Incorporated is announcing an information only notification.  The product datasheet(s) is being updated as summarized below.</p>			
		<b>THS4021, THS4022</b> SLOS265D – SEPTEMBER 1999 – REVISED MAY 2023	
<b>Changes from Revision C (July 2007) to Revision D (May 2023)</b>			<b>Page</b>
• Updated the numbering format for tables, figures, and cross-references throughout the document.....			1
• Added the <i>Applications, Specifications, Application and Implementation, Thermal Information Table, Pin Configuration and Functions, Electrical Characteristics: THS4021xD, Typical Characteristics: THS4021xD, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information</i> sections.....			1
• Changed data sheet title from "350-MHz Low-Noise High-Speed Amplifiers" to "2-GHz, 10-V/V Stable, Low-Noise, High-Speed Amplifiers" .....			1
• Changed front-page image from pin diagrams to simplified application.....			1
• Removed <i>Dissipation Ratings</i> section.....			6
• Changed supply voltage max in <i>Absolute Maximum Ratings</i> from $\pm 16.5$ V to 33 V for clarification.....			6
• Changed table note 1 on <i>Absolute Maximum Ratings</i> to add additional clarification.....			6
• Changed output current maximum value in <i>Absolute Maximum Ratings</i> from 150 mA to 240 mA.....			6
• Changed differential supply voltage maximum in <i>Absolute Maximum Ratings</i> table from $\pm 4$ V to $\pm 1.5$ V.....			6
• Added continuous input current in <i>Absolute Maximum Ratings</i> .....			6
• Added <i>Electrical Characteristics: THS4021 (D Package)</i> section.....			8
• Changed small-signal bandwidth at $G = 10$ , $V_{CC} = \pm 15$ V from 350 MHz to 290 MHz in <i>Electrical Characteristics: THS4021 (D Package)</i> .....			8
• Changed small-signal bandwidth at $G = 10$ , $V_{CC} = \pm 5$ V from 280 MHz to 250 MHz in <i>Electrical Characteristics: THS4021 (D Package)</i> .....			8
• Changed small-signal bandwidth at $G = 20$ , $V_{CC} = \pm 15$ V from 80 MHz to 110 MHz in <i>Electrical Characteristics: THS4021 (D Package)</i> .....			8
• Changed small-signal bandwidth at $G = 20$ , $V_{CC} = \pm 5$ V from 70 MHz to 100 MHz in <i>Electrical Characteristics: THS4021 (D Package)</i> .....			8
• Changed full power bandwidth calculation from slew rate / $[2 \pi V_{O(Peak)}]$ to slew rate / $[\pi V_{O(P-P)}]$ in <i>Electrical Characteristics THS4021 (D Package)</i> table note.....			8
• Changed full power bandwidth in <i>Electrical Characteristics: THS4021 (D Package)</i> table from 3.7 MHz to 7.5 MHz to match calculation infonote.....			8
• Changed full power bandwidth in <i>Electrical Characteristics: THS4021 (D Package)</i> table from 11.8 MHz to 23.6 MHz for $V_{CC} = \pm V$ to match calculation infonote.....			8
• Changed slew rate condition in <i>Electrical Characteristics: THS4021 (D Package)</i> from a 10-V step to a 20-V step for $V_{CC} = \pm 15$ V.....			8

• Changed 0.1% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 40 ns to 30 ns for $V_{CC} = \pm 15\text{ V}$ .....	8
• Changed 0.1% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 50 ns to 30 ns for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed 0.01% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 145 ns to 160 ns for $V_{CC} = \pm 15\text{ V}$ .....	8
• Changed 0.01% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 155 ns to 160 ns for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed input current noise specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 1.5 pA/ $\sqrt{\text{Hz}}$ to 1.2 pA/ $\sqrt{\text{Hz}}$ .....	8
• Changed input current noise specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 1.2 pA/ $\sqrt{\text{Hz}}$ to 2.3 pA/ $\sqrt{\text{Hz}}$ .....	8
• Changed open-loop gain load condition in <i>Electrical Characteristics: THS4021 (D Package)</i> from 250 $\Omega$ to 1 k $\Omega$ for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed open-loop gain typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 60 mV/V to 100 dB for $V_{CC} = \pm 15\text{ V}$ , $T_A = 25^\circ\text{C}$ .....	8
• Changed open-loop gain units from V/mV to dB in <i>Electrical Characteristics: THS4021 (D Package)</i> .....	8
• Changed open-loop gain typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 35 mV/V to 98 dB for $V_{CC} = \pm 5\text{ V}$ , $T_A = 25^\circ\text{C}$ .....	8
• Changed input offset voltage typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 0.5 mA to 0.3 mA for $25^\circ\text{C}$ .....	8
• Changed offset voltage drift typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 15 $\mu\text{A}/^\circ\text{C}$ to 2 $\mu\text{A}/^\circ\text{C}$ .....	8
• Changed input bias current typical in <i>Electrical Characteristics THS4021 (D Package)</i> from 3 $\mu\text{A}$ to 9 $\mu\text{A}$ for $T_A = 25^\circ\text{C}$ .....	8
• Changed input bias current maximum value in <i>Electrical Characteristics THS4021 (D Package)</i> from 6 $\mu\text{A}$ to 20 $\mu\text{A}$ for $T_A = 25^\circ\text{C}$ .....	8
• Changed input bias current maximum value in <i>Electrical Characteristics THS4021 (D Package)</i> from 8 $\mu\text{A}$ to 33 $\mu\text{A}$ for $T_A = \text{full range}$ .....	8
• Changed input offset current drift typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 0.3 nA/ $^\circ\text{C}$ to 0.2 nA/ $^\circ\text{C}$ .....	8
• Added Common-mode rejection ratio typical in <i>Electrical Characteristics: THS4021 (D Package)</i> for $25^\circ\text{C}$ .....	8
• Added common-mode rejection ratio in <i>Electrical Characteristics: THS4021 (D Package)</i> for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed output voltage swing typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from $\pm 12.5\text{ V}$ to $\pm 12.9\text{ V}$ for $V_{CC} = \pm 15\text{ V}$ , $R_L = 250\text{ }\Omega$ .....	8
• Changed output current load resistance typical value in <i>Electrical Characteristics THS4021 (D Package)</i> from 20 $\Omega$ to 10 $\Omega$ .....	8
• Changed output current typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 100 mA to 200 mA for $V_{CC} = \pm 15\text{ V}$ .....	8
• Changed output current typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 75 mA to 160 mA for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed output resistance in <i>Electrical Characteristics: THS4021 (D Package)</i> from 13 $\Omega$ to 5 $\Omega$ .....	8
• Changed supply current (each amplifier) typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 7.8 mA to 7.5 mA for $V_{CC} = \pm 5\text{ V}$ .....	8
• Changed supply current (each amplifier) typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 6.7 mA to 6.5 mA for $V_{CC} = \pm 5\text{ V}$ .....	8
• Added power-supply rejection ratio typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> .....	8
• Changed title of <i>Electrical Characteristics</i> to <i>Electrical Characteristics: THS4021 (D Package) and THS4022 (D and DGN Packages)</i> .....	10
• Added <i>Typical Characteristics: THS4021 (D Package)</i> section.....	12

• Changed title of <i>Typical Characteristics</i> to <i>Typical Characteristics: THS4021 (D Package) and THS4022 (D and DGN Packages)</i> N.....	17
• Added <i>Detailed Description</i> section.....	22
• Deleted <i>Noise Calculation and Noise Figure</i> and <i>Offset Voltage</i> sections.....	22
• Changed device label from "THS402x" to "THS4021" in <a href="#">Figure 7-4</a> .....	23
• Changed <i>Application Information</i> section to latest standard format.....	24
• Added <i>Power Supply Recommendations</i> section.....	25
• Changed title of <i>Circuit Layout Considerations</i> section to <i>Layout Guidelines</i> , updated content, and moved to <i>Layout</i> section.....	25
• Deleted thermal calculations and plots from <i>General PowerPAD™ Integrated Circuit Package Design Considerations</i> .....	26
• Deleted <i>Evaluation Board</i> section.....	26

The datasheet number will be changing.

Device Family	Change From:	Change To:
THS402x	SLOS265C	SLOS265D

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/THS4021>

#### Reason for Change:

To accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

THS4021CD	THS4021CDGN	THS4021CDGNR	THS4021ID
THS4021IDGN	THS4021IDGNR	THS4021IDR	THS4022CD
THS4022CDGN	THS4022CDGNR	THS4022ID	THS4022IDGN
THS4022IDGNR			

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	<a href="mailto:PCN_ww_admin_team@list.ti.com">PCN_ww_admin_team@list.ti.com</a>

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